

1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings†

Drain-to-Source Voltage	BV_{DSS}
Drain-to-Gate Voltage	BV_{DGS}
Gate-to-Source Voltage	$\pm 20V$
Junction Temperature, T_J	$-55^{\circ}C$ to $+150^{\circ}C$
Storage Temperature, T_S	$-55^{\circ}C$ to $+150^{\circ}C$

† **Notice:** Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.

DC ELECTRICAL CHARACTERISTICS – COMMERCIAL

Electrical Specifications: $T_A = T_J = 25^{\circ}C$ unless otherwise specified. All DC parameters are 100% tested at $25^{\circ}C$ unless otherwise stated. (Pulse test: 300 μs pulse, 2% duty cycle.)

Parameter	Sym.	Min.	Typ.	Max.	Unit	Conditions
Drain-to-Source Breakdown Voltage	BV_{DSS}	-350	—	—	V	$V_{GS} = 0V$, $I_D = -100 \mu A$
Gate Threshold Voltage	$V_{GS(th)}$	-1	—	-2.4	V	$V_{DS} = V_{GS}$, $I_D = -1 mA$
Change in $V_{GS(th)}$ with Temperature	$\Delta V_{GS(th)}$	—	—	4.5	mV/ $^{\circ}C$	$V_{DS} = V_{GS}$, $I_D = -1 mA$ (Note 1)
Gate Body Leakage	I_{GSS}	—	—	-100	nA	$V_{GS} = \pm 20V$, $V_{DS} = 0V$
Zero-Gate Voltage Drain Current	I_{DSS}	—	—	-10	μA	$V_{DS} = \text{Maximum rating}$, $V_{GS} = 0V$
		—	—	-1	mA	$V_{DS} = \text{Maximum rating}$, $V_{GS} = 0V$, $T_A = 125^{\circ}C$ (Note 1)
On-State Drain Current	$I_{D(ON)}$	-200	—	—	mA	$V_{GS} = -4.5V$, $V_{DS} = -25V$
		-400	—	—	mA	$V_{GS} = -10V$, $V_{DS} = -25V$
Static Drain-to-Source On-State Resistance	$R_{DS(ON)}$	—	—	75	Ω	$V_{GS} = -4.5V$, $I_D = -150 mA$
		—	—	30	Ω	$V_{GS} = -10V$, $I_D = -200 mA$
Change in $R_{DS(ON)}$ with Temperature	$\Delta R_{DS(ON)}$	—	—	1.7	%/ $^{\circ}C$	$V_{GS} = -10V$, $I_D = -200 mA$ (Note 1)

Note 1: Specification is obtained by characterization and is not 100% tested.

DC ELECTRICAL CHARACTERISTICS – AUTOMOTIVE

Electrical Specifications: $T_A = T_J = (-55^{\circ}C, 25^{\circ}C, \text{ or } 150^{\circ}C)$ unless otherwise specified. All DC parameters are 100% tested at all three temperatures unless otherwise stated. (Pulse test: 300 μs pulse, 2% duty cycle.)

Parameter	Sym.	Min.	Typ.	Max.	Unit	Conditions
Drain-to-Source Breakdown Voltage	BV_{DSS}	-350	—	—	V	$V_{GS} = 0V$, $I_D = -100 \mu A$
Gate Threshold Voltage	$V_{GS(th)}$	-1	—	-2.4	V	$V_{DS} = V_{GS}$, $I_D = -1 mA$
Change in $V_{GS(th)}$ with Temperature	$\Delta V_{GS(th)}$	—	3.3	—	mV/ $^{\circ}C$	$V_{DS} = V_{GS}$, $I_D = -1 mA$ (Note 1)
Gate Body Leakage	I_{GSS}	—	—	-100	nA	$V_{GS} = \pm 20V$, $V_{DS} = 0V$
		—	—	-220	nA	$V_{GS} = \pm 20V$, $V_{DS} = 0V$, $T_A = 150^{\circ}C$

Note 1: Specification is obtained by characterization and is not 100% tested.

DC ELECTRICAL CHARACTERISTICS – AUTOMOTIVE (CONTINUED)

Electrical Specifications: $T_A = T_J = (-55^{\circ}\text{C}, 25^{\circ}\text{C}, \text{ or } 150^{\circ}\text{C})$ unless otherwise specified. All DC parameters are 100% tested at all three temperatures unless otherwise stated. (Pulse test: 300 μs pulse, 2% duty cycle.)

Parameter	Sym.	Min.	Typ.	Max.	Unit	Conditions
Zero-Gate Voltage Drain Current	I_{DSS}	—	—	-10	μA	$V_{\text{DS}} = \text{Maximum rating}, V_{\text{GS}} = 0\text{V}$
		—	—	-1	mA	$V_{\text{DS}} = \text{Maximum rating}, V_{\text{GS}} = 0\text{V}, T_A = 150^{\circ}\text{C}$
On-State Drain Current	$I_{\text{D(ON)}}$	-200	—	—	mA	$V_{\text{GS}} = -4.5\text{V}, V_{\text{DS}} = -25\text{V}$
		-400	—	—	mA	$V_{\text{GS}} = -10\text{V}, V_{\text{DS}} = -25\text{V}$
		-375	—	—	mA	$V_{\text{GS}} = -10\text{V}, V_{\text{DS}} = -25\text{V}, T_A = 150^{\circ}\text{C}$
Static Drain-to-Source On-State Resistance	$R_{\text{DS(ON)}}$	—	—	75	Ω	$V_{\text{GS}} = -4.5\text{V}, I_{\text{D}} = -150\text{ mA}$
		—	—	30	Ω	$V_{\text{GS}} = -10\text{V}, I_{\text{D}} = -200\text{ mA}$
		—	—	70	Ω	$V_{\text{GS}} = -10\text{V}, I_{\text{D}} = -200\text{ mA}, T_A = 150^{\circ}\text{C}$
Change in $R_{\text{DS(ON)}}$ with Temperature	$\Delta R_{\text{DS(ON)}}$	—	1	—	$\%/^{\circ}\text{C}$	$V_{\text{GS}} = -10\text{V}, I_{\text{D}} = -200\text{ mA}$ (Note 1)

Note 1: Specification is obtained by characterization and is not 100% tested.

AC ELECTRICAL CHARACTERISTICS – COMMERCIAL

Electrical Specifications: $T_A = T_J = 25^{\circ}\text{C}$ unless otherwise specified. Specification is obtained by characterization and is not 100% tested.

Parameter	Sym.	Min.	Typ.	Max.	Unit	Conditions
Forward Transconductance	G_{FS}	125	—	—	mmho	$V_{\text{DS}} = -25\text{V}, I_{\text{D}} = -200\text{ mA}$
Input Capacitance	C_{ISS}	—	—	110	pF	$V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = -25\text{V}, f = 1\text{ MHz}$
Common Source Output Capacitance	C_{OSS}	—	—	60	pF	
Reverse Transfer Capacitance	C_{RSS}	—	—	22	pF	
Turn-On Delay Time	$t_{\text{d(ON)}}$	—	—	20	ns	$V_{\text{DD}} = -25\text{V}, I_{\text{D}} = -150\text{ mA}, R_{\text{GEN}} = 25\Omega$
Rise Time	t_{r}	—	—	15	ns	
Turn-Off Delay Time	$t_{\text{d(OFF)}}$	—	—	25	ns	
Fall Time	t_{f}	—	—	25	ns	

DIODE PARAMETER

Diode Forward Voltage Drop	V_{SD}	—	—	-1.8	V	$V_{\text{GS}} = 0\text{V}, I_{\text{SD}} = -200\text{ mA}$ (Note 1)
Reverse Recovery Time	t_{rr}	—	800	—	ns	$V_{\text{GS}} = 0\text{V}, I_{\text{SD}} = -200\text{ mA}$

Note 1: All DC parameters are 100% tested at 25°C unless otherwise stated. (Pulse test: 300 μs pulse, 2% duty cycle.)

AC ELECTRICAL CHARACTERISTICS – AUTOMOTIVE

Electrical Specifications: $T_A = T_J = 25^\circ\text{C}$ unless otherwise specified. Specification is obtained by characterization and is not 100% tested.

Parameter	Sym.	Min.	Typ.	Max.	Unit	Conditions
Forward Transconductance	G _{FS}	—	285	—	mmho	V _{DS} = −25V, I _D = −200 mA
Input Capacitance	C _{ISS}	—	80	—	pF	V _{GS} = 0V, V _{DS} = −25V, f = 1 MHz
Common Source Output Capacitance	C _{OSS}	—	12	—	pF	
Reverse Transfer Capacitance	C _{RSS}	—	2	—	pF	
Turn-On Delay Time	t _{d(ON)}	—	7.6	—	ns	V _{DD} = −25V, I _D = −150 mA, R _{GEN} = 25Ω
Rise Time	t _r	—	3	—	ns	
Turn-Off Delay Time	t _{d(OFF)}	—	19	—	ns	
Fall Time	t _f	—	10	—	ns	
DIODE PARAMETER						
Diode Forward Voltage Drop	V _{SD}	—	—	−1.8	V	V _{GS} = 0V, I _{SD} = −200 mA (Note 1)
Reverse Recovery Time	t _{rr}	—	450	—	ns	V _{GS} = 0V, I _{SD} = −200 mA

Note 1: 100% Production Tested at $T_A = T_J = (-55^\circ\text{C}, 25^\circ\text{C}, \text{ and } 150^\circ\text{C})$.

TEMPERATURE SPECIFICATIONS

Parameter	Sym.	Min.	Typ.	Max.	Unit	Conditions
TEMPERATURE RANGE						
Operating Junction Temperature	T_J	-55	—	+150	$^\circ\text{C}$	
Storage Temperature	T_S	-55	—	+150	$^\circ\text{C}$	
PACKAGE THERMAL RESISTANCE						
3-lead SOT-23	θ_{JA}	—	203	—	$^\circ\text{C/W}$	

THERMAL CHARACTERISTICS

Package	I_D (Note 1) (Continuous) (mA)	I_D (Pulsed) (mA)	Power Dissipation at $T_A = 25^\circ\text{C}$ (W)	I_{DR} (Note 1) (mA)	I_{DRM} (mA)
3-lead SOT-23	-85	-400	0.36	-85	-400

Note 1: I_D (continuous) is limited by maximum T_J .

2.0 PIN DESCRIPTION

Table 2-1 shows the description of pins in TP5335 SOT-23. Refer to [Package Type](#) for the location of pins.

TABLE 2-1: PIN FUNCTION TABLE

Pin Number	Pin Name	Description
1	Gate	Gate
2	Source	Source
3	Drain	Drain

3.0 FUNCTIONAL DESCRIPTION

Figure 3-1 illustrates the switching waveforms and test circuit for TP5335.

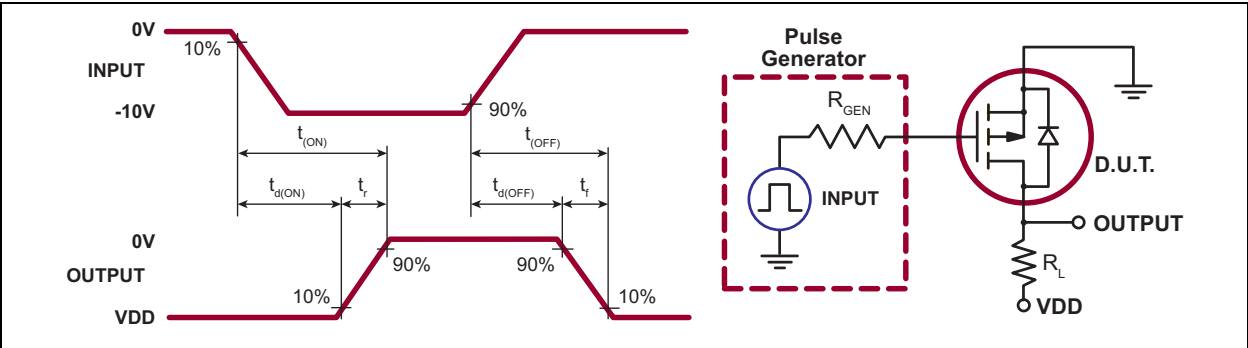


FIGURE 3-1: Switching Waveforms and Test Circuit.

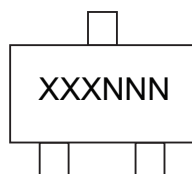
TABLE 3-1: PRODUCT SUMMARY

BV_{DSS}/BV_{DGS} (V)	$R_{DS(ON)}$ (Maximum) (Ω)	$V_{GS(th)}$ (Maximum) (V)
-350	30	-2.4

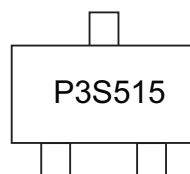
4.0 PACKAGING INFORMATION

4.1 Package Marking Information

3-lead SOT-23



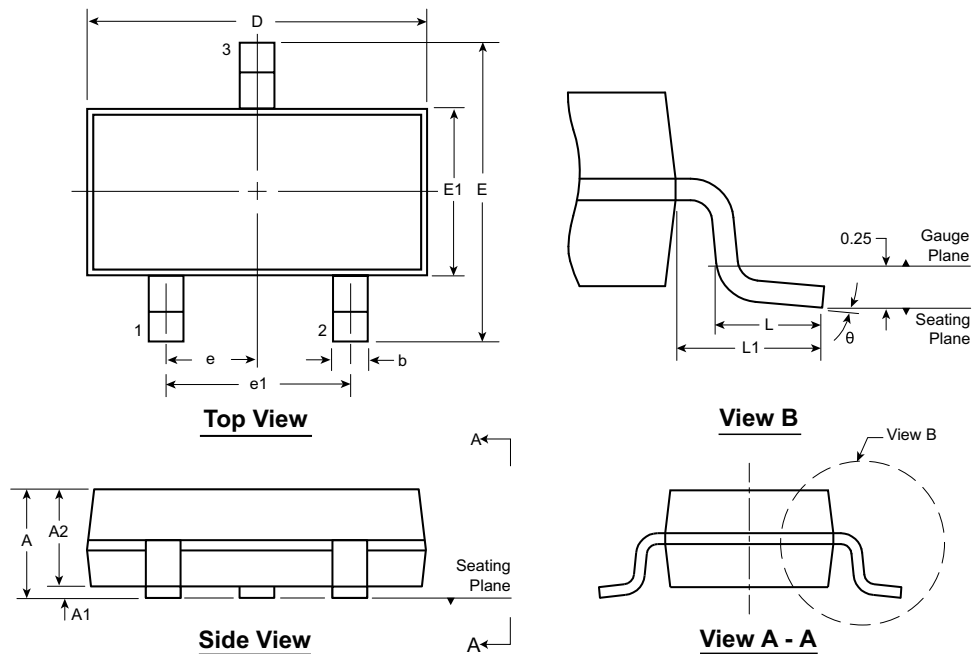
Example



Legend:	XX...X	Product Code or Customer-specific information
	Y	Year code (last digit of calendar year)
	YY	Year code (last 2 digits of calendar year)
	WW	Week code (week of January 1 is week '01')
	NNN	Alphanumeric traceability code
	(e3)	Pb-free JEDEC [®] designator for Matte Tin (Sn)
	*	This package is Pb-free. The Pb-free JEDEC designator (e3) can be found on the outer packaging for this package.

Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for product code or customer-specific information. Package may or not include the corporate logo.

3-Lead TO-236AB (SOT-23) Package Outline (K1/T) 2.90x1.30mm body, 1.12mm height (max), 1.90mm pitch



Note: For the most current package drawings, see the Microchip Packaging Specification at www.microchip.com/packaging.

Symbol		A	A1	A2	b	D	E	E1	e	e1	L	L1	θ
Dimension (mm)	MIN	0.89	0.01	0.88	0.30	2.80	2.10	1.20	0.95 BSC	1.90 BSC	0.20 [†]	0.54 REF	0°
	NOM	-	-	0.95	-	2.90	-	1.30			0.50		-
	MAX	1.12	0.10	1.02	0.50	3.04	2.64	1.40			0.60		8°

JEDEC Registration TO-236, Variation AB, Issue H, Jan. 1999.

[†] This dimension differs from the JEDEC drawing.

Drawings not to scale.

APPENDIX A: REVISION HISTORY

Revision A (December 2018)

- Converted Supertex Doc# DSFP-TP5335 to Microchip DS20005704A
- Made minor text changes throughout the document

Revision B (February 2020)

- Revised the order of pins in the Pin Function Table
- Revised the Electrical Specifications and included notes in the DC Electrical Characteristics and AC Electrical Characteristics tables
- Made minor text changes throughout the document

Revision C (June 2020)

- Added automotive specifications to the Electrical Characteristics section
- Added automotive specifications to the Product Identification System section
- Made minor text changes throughout the document

TP5335

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, contact your local Microchip representative or sales office.

<u>PART NO.</u>	<u>XX</u>	-	<u>X</u>	-	<u>X</u>	-	<u>X</u>
Device	Package Options		Environmental		Media Type		Option
Device:	TP5335	=	P-Channel Enhancement-Mode Vertical DMOS FET				
Package:	K1	=	3-lead SOT-23				
Environmental:	G	=	Lead (Pb)-free/RoHS-compliant Package				
Media Type:	(blank)	=	3000/Reel for a K1 Package				
Option:	VAO	=	Automotive Grade				

Example:

a) TP5335K1-G: P-Channel Enhancement-Mode Vertical DMOS FET, 3-lead SOT-23, 3000/Reel

b) TP5335K1-G-VAO: P-Channel Enhancement-Mode Vertical DMOS FET, Automotive Grade, 3-lead SOT-23, 3000/Reel

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